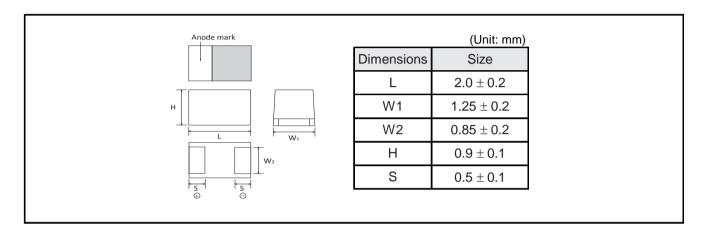
Conductive polymer chip capacitors (New Bottom surface electrode type: Extra Large capacitance) TCSO Series PL Case

Datasheet

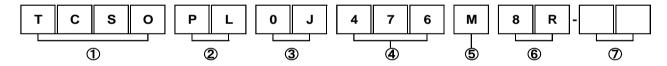
Features

- 1) Conductive polymer used at the cathode for ultra-low ESR.
- 2) New package structure results in the largest capacitance.
- 3) Compact, low profile, ultra-high capacitance contributes to smaller, thinner sets with greater functionality.
- 4) Conductive polymer has a self-healing function that prevents failure, resulting in safe, high reliability operation.

Dimensions



● Part No. Explanation



- ① Series name TCSO
- ② Case style

PL: 2012-10 (0805) Low profile size

3 Rated voltage

CODE	Rated voltage (V)
0J	6.3
1A	10
1E	25

4 Nominal capacitance

Nominal capacitance in pF in 3 digits: 2 significant figures followed by the figure representing the number of 0's.

⑤ Capacitance tolerance

M: ±20%

6 Taping

8: Tape width

R: Positive electrode on the side opposite to sprocket hole

⑦ Discrimination code

^{*}This specification has possibility of charge, due to underdevelopment product. Please ask for latest specification to our sales.

Rated table

 $(ESR : m\Omega)$

			(==:::::)			
Capacitance	Rated voltage (V.DC)					
(µF)	6.3	10	25			
4.7 (475)			500			
22 (226)		200				
33 (336)		☆200				
47 (476)	150 / 200					
68 (686)	☆ 150 / ☆ 200					

Marking

The indications listed below should be given on the surface of a capacitor.

- (1) Polarity: The polarity should be shown by □ bar. (on the anode side)
- (2) Rated DC voltage: A voltage code is shown as below table.
- (3) Capacitance: A capacitance code is shown as below table.

Voltage Code	Rated DC Voltage (V)		
j	6.3		
А	10		
Е	25		

Capacitance Code	Nominal Capacitance (μ F)		
S	4.7		
j	22		
n	33		
S	47		
W	68		

Visual typical example

voltage code and capacitance code are variable with parts number.

EX.)

$$\frac{j}{(1)}$$
 $\frac{s}{(2)}$

(1) voltage code (2) capacitance code



Characteristics

	Item Performance		Test condi	tions (based on JIS C 510	1-1 and JIS C 5101-3)				
Operating Temperature Maximum operating temperature			+105°C			Voltage reduction wher	temperature exceeds +8	5°C	
Maximum opera with no voltage	•	+85°C							
Rated voltage (\	/.DC)	2.5	4	6.3	10	at 85°C			
Category voltage	e (V.DC)	2	3.2	5	8	at 105°C			
Surge voltage (V.DC) 3.2 5 8 13		at 85°C							
ĕ		Shall be Standard	satisfied t I list "	he value	on "	As per 4.9 JIS C 5101-1 As per 4.5.1 JIS C 5101-3 Voltage: Rated voltage for 5min			
Capacitance tole	erance	Shall be ±20%	satisfied a	As per 4.7 JIS C 5101-1 As per 4.5.2 JIS C 5101-3 Measuring frequency: 120±12Hz Measuring voltage: 0.5Vrms + 1.5V.DC Measuring circuit: DC equivalent series circuit					
Tangent of loss	angle (Df, $tan \delta$)	Shall be Standard		he voltag	Measuring circuit: DC equivalent series circuit As per 4.8 JIS C 5101-1 As per 4.5.3 JIS C 5101-3 Measuring frequency: 120±12Hz Measuring voltage: 0.5Vrms + 1.5V.DC Measuring circuit: DC equivalent series circuit				
ESR			all be satisfied the value on " Indard list "			As per 4.5.4 JIS C 5101-1 As per 4.5.4 JIS C 5101-3 Measuring frequency: 100±10kHz Measuring voltage: 0.5Vrms or less Measuring circuit: DC equivalent series circuit			
Resistance to Soldering heat	Appearance					As per 4.14 JIS C 5101 As per 4.6 JIS C 5101- Dip in the solder bath			
	L.C.	Less tha	n 300% o	f initial lim	nit	Solder temp. : 240±5°C Duration : 10±0.5s			
	⊿c/c	Within ±2	20% of ini	tial value		•	ave it at room temperature	e for over 24h and then meas	
	Df (tan δ)	Less tha	n 300% o	f initial lim	nit	the sample.			
Temperature cycle Appearance		abnormality. The indications should be clear.				As per 4.16 JIS C 5101 As per 4.10 JIS C 5101 Repetition : 5 cycles (1 cycle : steps 1 to 4)			
							Temp.	Time	
	L.C.	Less tha	n 1000%	of initial li	mit	1	−55±3°C	30±3min.	
						2	Room temp.	3min. or less	
	10.15	<u> </u>				3	105±2°C	30±3min.	
	⊿c/c	Within ±2	20% of ini	tial value		After the specimens, le the sample.	Room temp. ave it at room temperature	3min. or less e for over 24h and then meas	
						•			
	Df (tan δ)	Less tha	n 300% o	f initial lim	nit				
Moisture resistance	Df (tan δ) Appearance	There sh	ould be n lity. The i	o significa	ant	As per 4.22 JIS C 5101 As per 4.12 JIS C 5101 After leaving the sampl	-3	condition that the temperatu	
	` ′	There sh abnorma be clear.	ould be n lity. The i	o significandications	ant s should	As per 4.12 JIS C 5101 After leaving the sampl humidity are 40±2°C an	-3 e under such atmospherion ad 90 to 95% RH, respecti	veiy, for 500±12h leave it at re	
	Appearance	There sh abnorma be clear. Less tha	ould be n lity. The i	o significandications	ant s should nit	As per 4.12 JIS C 5101 After leaving the sampl humidity are 40±2°C an	-3 e under such atmospherio	veiy, for 500±12h leave it at re	

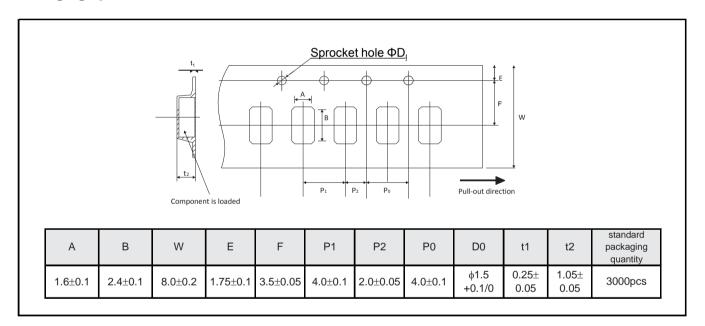
	em	Performance	Test conditions (based on JIS C 5101–1 and JIS C 5101–3)				
Temperature Stability	Temp.	–55°C	As per 4.29 JIS C 5101-1				
Stability	⊿c/c	Within 0/–20% of initial value	As per 4.13 JIS C 5101-3				
	Df (tan δ)	Shall be satisfied the value on " Standard list "					
	L.C.	-					
	Temp.	+105°C					
	⊿c/c	Within +50/0% of initial value					
	Df (tan δ)	Shall be satisfied the value on " Standard list "					
	L.C.	Less than 1,000% of initial value					
Surge voltage	Appearance	There should be no significant abnormality. The indications should be clear.	As per 4.26JIS C 5101-1 As per 4.14JIS C 5101-3 Apply the specified surge voltage via the serial resistance of $1k\Omega$ ever				
	L.C.	Less than 200% of initial limit	5±0.5 min. for 30±5 s. each time in the atmospheric condition of 85± 2°C. Repeat this procedure 1,000 times.				
	△C / C Within ±20% of initial value		After the specimens, leave it at room temperature for over 24h and				
	Df (tan δ)	Less than 200% of initial limit	then measure the sample.				
Loading at High temperature	Appearance	There should be no significant abnormality. The indications should be clear.	As per 4.23 JIS C 5101-1 As per 4.15 JIS C 5101-3				
	L.C.	Less than 400% of initial limit	After applying the rated voltage for 1000+72/0 h without discontinuati via the serial resistance of 3Ω or less at a temperature of 85±2°C,				
	⊿c/c	Within ±20% of initial value	leave the sample at room temperature / humidity for over 24h and				
	Df (tan δ)	Less than 300% of initial limit	measure the value.				
Terminal strength	Capacitance	The measured value should be stable.	As per 4.35 JIS C 5101-1				
			As per 4.9 JIS C 5101-3 A force is applied to the terminal until it bends to 1mm and by a prescribed tool maintains the condition for 5s.				
	Appearance	There should be no significant abnormality.	(See the figure below)				
			(Unit: mm)				
			50, 20 F (Apply force)				
			F (Apply force)				
			(R230)				
			→ • - • - • - • - • • • • • • • • • • • • • • • • • • •				
			thickness=1.6mm				
			45 45				
Adhesiveness		The terminal should not come off.	As per 4.34 JIS C 5101-1				
Adhesiveness		The terminal should not come off.	As per 4.34 JIS C 5101-1 As per 4.8 JIS C 5101-3				
Adhesiveness		The terminal should not come off.	As per 4.8 JIS C 5101-3 Apply force of 5N in the two directions shown in the figure below for 10				
Adhesiveness		The terminal should not come off.	As per 4.8 JIS C 5101-3 Apply force of 5N in the two directions shown in the figure below for 10 ±1s after mounting the terminal on a circuit board.				
Adhesiveness		The terminal should not come off.	As per 4.8 JIS C 5101-3 Apply force of 5N in the two directions shown in the figure below for 10 ±1s after mounting the terminal on a circuit board. product				
Adhesiveness		The terminal should not come off.	As per 4.8 JIS C 5101-3 Apply force of 5N in the two directions shown in the figure below for 10 ±1s after mounting the terminal on a circuit board.				
Adhesiveness	L	The terminal should not come off.	As per 4.8 JIS C 5101-3 Apply force of 5N in the two directions shown in the figure below for 10 ±1s after mounting the terminal on a circuit board. product				
Adhesiveness	l	The terminal should not come off.	As per 4.8 JIS C 5101-3 Apply force of 5N in the two directions shown in the figure below for 10 ±1s after mounting the terminal on a circuit board. product Apply force				
Adhesiveness	ı	The terminal should not come off.	As per 4.8 JIS C 5101-3 Apply force of 5N in the two directions shown in the figure below for 10 ±1s after mounting the terminal on a circuit board. product				
		The terminal should not come off. Refer to "External dimensions"	As per 4.8 JIS C 5101-3 Apply force of 5N in the two directions shown in the figure below for 10 ±1s after mounting the terminal on a circuit board. product Apply force				
Dimensions	vents		As per 4.8 JIS C 5101-3 Apply force of 5N in the two directions shown in the figure below for 10 ±1s after mounting the terminal on a circuit board. product Apply force a circuit board				
Dimensions	vents	Refer to "External dimensions"	As per 4.8 JIS C 5101-3 Apply force of 5N in the two directions shown in the figure below for 10 ±1s after mounting the terminal on a circuit board. product Apply force a circuit board Measure using a caliper of JIS B 7507 Class 2 or higher grade As per 4.32 JIS C 5101-1 As per 4.18 JIS C 5101-3				
Dimensions	vents	Refer to "External dimensions"	As per 4.8 JIS C 5101-3 Apply force of 5N in the two directions shown in the figure below for 10 ±1s after mounting the terminal on a circuit board. product Apply force a circuit board Measure using a caliper of JIS B 7507 Class 2 or higher grade As per 4.32 JIS C 5101-1				
Dimensions Resistance to solv	vents	Refer to "External dimensions" The indication should be clear. 3/4 or more surface area of the solder coated	As per 4.8 JIS C 5101-3 Apply force of 5N in the two directions shown in the figure below for 10 ±1s after mounting the terminal on a circuit board. product Apply force a circuit board Measure using a caliper of JIS B 7507 Class 2 or higher grade As per 4.32 JIS C 5101-1 As per 4.18 JIS C 5101-3 Dip in the isopropyl alcohol for 30±5s, at room temperature. As per 4.15.2 JIS C 5101-1				
Adhesiveness Dimensions Resistance to solv	vents	Refer to "External dimensions" The indication should be clear. 3/4 or more surface area of the solder coated terminal dipped in the soldering bath should be	As per 4.8 JIS C 5101-3 Apply force of 5N in the two directions shown in the figure below for 10 ±1s after mounting the terminal on a circuit board. product Apply force a circuit board Measure using a caliper of JIS B 7507 Class 2 or higher grade As per 4.32 JIS C 5101-1 As per 4.18 JIS C 5101-3 Dip in the isopropyl alcohol for 30±5s, at room temperature. As per 4.7 JIS C 5101-1 As per 4.7 JIS C 5101-3				
Dimensions Resistance to solv	vents	Refer to "External dimensions" The indication should be clear. 3/4 or more surface area of the solder coated	As per 4.8 JIS C 5101-3 Apply force of 5N in the two directions shown in the figure below for 10 ±1s after mounting the terminal on a circuit board. product Apply force a circuit board Measure using a caliper of JIS B 7507 Class 2 or higher grade As per 4.32 JIS C 5101-1 As per 4.18 JIS C 5101-3 Dip in the isopropyl alcohol for 30±5s, at room temperature. As per 4.7 JIS C 5101-1 As per 4.7 JIS C 5101-3 Dip speed: 25±2.5mm / s				
Dimensions Resistance to solv	vents	Refer to "External dimensions" The indication should be clear. 3/4 or more surface area of the solder coated terminal dipped in the soldering bath should be	As per 4.8 JIS C 5101-3 Apply force of 5N in the two directions shown in the figure below for 10 ±1s after mounting the terminal on a circuit board. product Apply force a circuit board Measure using a caliper of JIS B 7507 Class 2 or higher grade As per 4.32 JIS C 5101-1 As per 4.18 JIS C 5101-3 Dip in the isopropyl alcohol for 30±5s, at room temperature. As per 4.7 JIS C 5101-1 As per 4.7 JIS C 5101-3				
Dimensions Resistance to solv	vents	Refer to "External dimensions" The indication should be clear. 3/4 or more surface area of the solder coated terminal dipped in the soldering bath should be	As per 4.8 JIS C 5101-3 Apply force of 5N in the two directions shown in the figure below for 10 ±1s after mounting the terminal on a circuit board. product Apply force a circuit board Measure using a caliper of JIS B 7507 Class 2 or higher grade As per 4.32 JIS C 5101-1 As per 4.18 JIS C 5101-3 Dip in the isopropyl alcohol for 30±5s, at room temperature. As per 4.7 JIS C 5101-3 Dip speed: 25±2.5mm / s Pre-treatment (accelerated aging): Leave the sample on the boiling distilled water for 1 h. Solder temp.: 245±5°C				
Dimensions Resistance to solv	vents	Refer to "External dimensions" The indication should be clear. 3/4 or more surface area of the solder coated terminal dipped in the soldering bath should be	As per 4.8 JIS C 5101-3 Apply force of 5N in the two directions shown in the figure below for 10 ±1s after mounting the terminal on a circuit board. product Apply force a circuit board Measure using a caliper of JIS B 7507 Class 2 or higher grade As per 4.32 JIS C 5101-1 As per 4.18 JIS C 5101-3 Dip in the isopropyl alcohol for 30±5s, at room temperature. As per 4.7 JIS C 5101-1 As per 4.7 JIS C 5101-3 Dip speed: 25±2.5mm / s Pre-treatment (accelerated aging): Leave the sample on the boiling distilled water for 1 h. Solder temp.: 245±5°C Duration: 3±0.5s				
Dimensions Resistance to solv	vents	Refer to "External dimensions" The indication should be clear. 3/4 or more surface area of the solder coated terminal dipped in the soldering bath should be	As per 4.8 JIS C 5101-3 Apply force of 5N in the two directions shown in the figure below for 10 ±1s after mounting the terminal on a circuit board. product Apply force a circuit board Measure using a caliper of JIS B 7507 Class 2 or higher grade As per 4.32 JIS C 5101-1 As per 4.18 JIS C 5101-3 Dip in the isopropyl alcohol for 30±5s, at room temperature. As per 4.7 JIS C 5101-1 As per 4.7 JIS C 5101-3 Dip speed: 25±2.5mm / s Pre-treatment (accelerated aging): Leave the sample on the boiling distilled water for 1 h. Solder temp.: 245±5°C				
Dimensions Resistance to solv Solderability		Refer to "External dimensions" The indication should be clear. 3/4 or more surface area of the solder coated terminal dipped in the soldering bath should be covered with the new solder.	As per 4.8 JIS C 5101-3 Apply force of 5N in the two directions shown in the figure below for 10 ±1s after mounting the terminal on a circuit board. product Apply force a circuit board Measure using a caliper of JIS B 7507 Class 2 or higher grade As per 4.32 JIS C 5101-1 As per 4.18 JIS C 5101-3 Dip in the isopropyl alcohol for 30±5s, at room temperature. As per 4.7 JIS C 5101-3 Dip speed: 25±2.5mm / s Pre-treatment (accelerated aging): Leave the sample on the boiling distilled water for 1 h. Solder temp.: 245±5°C Duration: 3±0.5s Solder: M705 Flux: Rosin 25% IPA 75%				
Dimensions Resistance to solv Solderability	vents	Refer to "External dimensions" The indication should be clear. 3/4 or more surface area of the solder coated terminal dipped in the soldering bath should be	As per 4.8 JIS C 5101-3 Apply force of 5N in the two directions shown in the figure below for 10 ±1s after mounting the terminal on a circuit board. product Apply force a circuit board Measure using a caliper of JIS B 7507 Class 2 or higher grade As per 4.32 JIS C 5101-1 As per 4.18 JIS C 5101-3 Dip in the isopropyl alcohol for 30±5s, at room temperature. As per 4.7 JIS C 5101-1 As per 4.7 JIS C 5101-3 Dip speed: 25±2.5mm / s Pre-treatment (accelerated aging): Leave the sample on the boiling distilled water for 1 h. Solder temp.: 245±5°C Duration: 3±0.5s Solder: M705 Flux: Rosin 25% IPA 75% As per 4.17 JIS C 5101-1 Frequency: 10 to 55 to 10Hz/min.				
Dimensions Resistance to solv		Refer to "External dimensions" The indication should be clear. 3/4 or more surface area of the solder coated terminal dipped in the soldering bath should be covered with the new solder. Measure value should not fluctuate during the	As per 4.8 JIS C 5101-3 Apply force of 5N in the two directions shown in the figure below for 10 ±1s after mounting the terminal on a circuit board. product Apply force a circuit board Measure using a caliper of JIS B 7507 Class 2 or higher grade As per 4.32 JIS C 5101-1 As per 4.18 JIS C 5101-3 Dip in the isopropyl alcohol for 30±5s, at room temperature. As per 4.7 JIS C 5101-1 As per 4.7 JIS C 5101-3 Dip speed: 25±2.5mm / s Pre-treatment (accelerated aging): Leave the sample on the boiling distilled water for 1 h. Solder temp.: 245±5°C Duration: 3±0.5s Solder: M705 Flux: Rosin 25% IPA 75% As per 4.17 JIS C 5101-1				

Standard products list

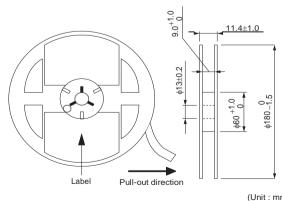
Part No.	Rated voltage 85°C	Category voltage 105°C	Surge voltage 85°C	Cap. 120Hz	Toleranc e	25°C		120Hz (%)		ESR 100kHz
	(V)	(V)	(V)	(μF)	(%)	1WV.5mi n (μ A)	–55°C	25°C	105°C	(mΩ)
TCSO PL 0J 476 M8R -ZF1	6.3	5	8	47	±20	29.7	15	15	20	150
TCSO PL 0J 476 M8R -ZD1	6.3	5	8	47	±20	29.7	15	15	20	200
* TCSO PL 0J 686 M8R -ZF1	6.3	5	8	68	±20	129.0	15	15	20	150
* TCSO PL 0J 686 M8R -ZD1	6.3	5	8	68	±20	129.0	15	15	20	200
TCSO PL 1A 226 M8R	10	8	13	22	±20	22.0	15	15	20	200
* TCSO PL 1A 336 M8R -ZD1	10	8	13	33	±20	33.0	15	15	20	200
TCSO PL 1E 475 M8R -ZT1	25	20	29	4.7	±20	11.8	10	10	15	500

^{*} Under development

Packaging specifications



Reel dimensions



(Unit : mm) EIAJ ET-7200A

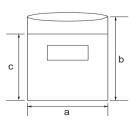
Damp proof package

1)One reel is packed in aluminum bag.

The size of aluminum bag is 240(a) x 250(b)mm.

The size up to 230(c)mm is to zipper.

- ②A desiccant is packed with a reel.
- 3The aluminum bag is heat-sealed.
- The label of the same as the label on the reel is placed on the aluminum bag.



Notice

Precaution on using ROHM Products

1. Our Products are designed and manufactured for application in ordinary electronic equipment (such as AV equipment, OA equipment, telecommunication equipment, home electronic appliances, amusement equipment, etc.). If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment (Note 1), transport equipment, traffic equipment, aircraft/spacecraft, nuclear power controllers, fuel controllers, car equipment including car accessories, safety devices, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM's Products for Specific Applications.

(Note1) Medical Equipment Classification of the Specific Applications

JAPAN	USA	EU	CHINA
CLASSⅢ	CLASSⅢ	CLASS II b	CI ACCIII
CLASSIV	CLASSIII	CLASSⅢ	CLASSIII

- 2. ROHM designs and manufactures its Products subject to strict quality control system. However, semiconductor products can fail or malfunction at a certain rate. Please be sure to implement, at your own responsibilities, adequate safety measures including but not limited to fail-safe design against the physical injury, damage to any property, which a failure or malfunction of our Products may cause. The following are examples of safety measures:
 - [a] Installation of protection circuits or other protective devices to improve system safety
 - [b] Installation of redundant circuits to reduce the impact of single or multiple circuit failure
- 3. Our Products are designed and manufactured for use under standard conditions and not under any special or extraordinary environments or conditions, as exemplified below. Accordingly, ROHM shall not be in any way responsible or liable for any damages, expenses or losses arising from the use of any ROHM's Products under any special or extraordinary environments or conditions. If you intend to use our Products under any special or extraordinary environments or conditions (as exemplified below), your independent verification and confirmation of product performance, reliability, etc, prior to use, must be necessary:
 - [a] Use of our Products in any types of liquid, including water, oils, chemicals, and organic solvents
 - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
 - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (Exclude cases where no-clean type fluxes is used. However, recommend sufficiently about the residue.); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse, is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

Precautions Regarding Application Examples and External Circuits

- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
- 2. You agree that application notes, reference designs, and associated data and information contained in this document are presented only as guidance for Products use. Therefore, in case you use such information, you are solely responsible for it and you must exercise your own independent verification and judgment in the use of such information contained in this document. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of such information.

Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period
 may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is
 exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

Precaution for Product Label

A two-dimensional barcode printed on ROHM Products label is for ROHM's internal use only.

Precaution for Disposition

When disposing Products please dispose them properly using an authorized industry waste company.

Precaution for Foreign Exchange and Foreign Trade act

Since concerned goods might be fallen under listed items of export control prescribed by Foreign exchange and Foreign trade act, please consult with ROHM in case of export.

Precaution Regarding Intellectual Property Rights

- 1. All information and data including but not limited to application example contained in this document is for reference only. ROHM does not warrant that foregoing information or data will not infringe any intellectual property rights or any other rights of any third party regarding such information or data.
- 2. ROHM shall not have any obligations where the claims, actions or demands arising from the combination of the Products with other articles such as components, circuits, systems or external equipment (including software).
- 3. No license, expressly or implied, is granted hereby under any intellectual property rights or other rights of ROHM or any third parties with respect to the Products or the information contained in this document. Provided, however, that ROHM will not assert its intellectual property rights or other rights against you or your customers to the extent necessary to manufacture or sell products containing the Products, subject to the terms and conditions herein.

Other Precaution

- 1. This document may not be reprinted or reproduced, in whole or in part, without prior written consent of ROHM.
- 2. The Products may not be disassembled, converted, modified, reproduced or otherwise changed without prior written consent of ROHM.
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